

HT93LC46 CMOS 1K 3-Wire Serial EEPROM

Features

- Operating voltage: 2.2V~5.5V
- Low power consumption
- Operating: 5mA max.
- Standby: 10µA max.
- User selectable internal organization - 1K(HT93LC46): 128×8 or 64×16
- 3-wire Serial Interface
- Write cycle time: 5ms max.

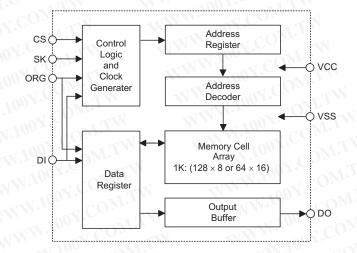
- Automatic erase-before-write operation
- Word/chip erase and write operation
- Write operation with built-in timer
- Software controlled write protection
- 10-year data retention after 100K rewrite cycles
- 10⁶ rewrite cycles per word
- Commercial temperature range (0°C to +70°C)
- 8-pin DIP/SOP/TSSOP package

General Description

The HT93LC46 is a 1K-bit low voltage nonvolatile, serial electrically erasable programmable read only memory device using the CMOS floating gate process. Its 1024 bits of memory are organized into 64 words of 16 bits each when the ORG pin is connected to VCC or organized into 128 words of 8 bits each when it is tied to VSS. The device is

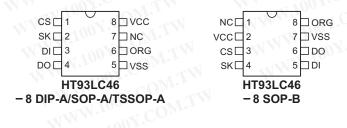
optimized for use in many industrial and commercial applications where low power and low voltage operation are essential. By popular microcontroller, the versatile serial interface including chip select (CS), serial clock (SK), data input (DI) and data output (DO) can be easily controlled.

Block Diagram



勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

Pin Assignment





勝特力材料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787

Http://www.100y.com.tw

HT93LC46

Pin Name	I/O	Description	
CS		Chip select input	
SK	1	Serial clock input	
DI	I	Serial data input	
DO	0	Serial data output	
VSS	_	Negative power supply, ground	
ORG		Internal Organization When ORG is connected to VDD or ORG is floated, the (×16) memory organization is se- lected. When ORG is tied to VSS, the (×8) memory organization is selected. There is an in- ternal pull-up resistor on the ORG pin.	
NC	TY.	No connection	
VCC COM		Positive power supply	

Absolute Maximum Ratings

Operation Temperature (Commercial)	0°C to 70°C
Applied V _{CC} Voltage with Respect to VSS	–0.3V to 6.0V
Applied Voltage on any Pin with Respect to VSS	$_{\rm VSS}$ –0.3V to V _{CC} +0.3V

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reli-WWW.100Y.COM ability. JOY.COM.TW

0h.e.l	W.100 COM.1		Test Conditions		Тур.	Max	
Symbol	Parameter	Vcc	Conditions	Min.		Max.	Unit
V _{CC}	Operating Voltage	T.M.	WW <u>100X</u>	2.2	<u>cn</u>	5.5	V
I _{CC1}	Operating Current (TTL)	5V	DO unload, SK=1MHz	1.0 <u>0</u>	TN	5	mA
1		5V	DO unload, SK=1MHz	N.COM	TTN I	5	mA
I _{CC2} Operati	Operating Current (CMOS)	2~5.5V	DO unload, SK=250kHz	N.CO		5	mA
I _{STB}	Standby Current (CMOS)	5V CS=SK=DI=0V		J CC	NF.	10	μΑ
ILI	Input Leakage Current	5V	V _{IN} =V _{SS} ~V _{CC}	0	$0^{\underline{M}.}$	1	μΑ
I _{LO}	Output Leakage Current	5V	V _{OUT} =V _{SS} ~V _{CC} , CS=0V	0	An	1	μΑ
V.		5V	$L_M = M_M$	0		0.8	V
V _{IL}	Input Low Voltage	2~5.5V	WW - WW	0		0.1V _{CC}	V
Maria	Innut Lligh Voltage	5V	WW = WW	2	N.CO	V _{CC}	V
V _{IH}	Input High Voltage	2~5.5V		0.9V _{CC}	A.C	V _{CC}	V
\/	Output Low Voltogo	5V	I _{OL} =2.1mA	N 41.1		0.4	V
V _{OL}	Output Low Voltage	2~5.5V	I _{OL} =10μA	_		0.2	V
	Output High Voltage	5V	I _{OH} =-400μA	2.4			V
V _{OH}	Output High Voltage	2~5.5V	I _{OH} =-10μA	V _{CC} -0.2			V
C _{IN}	Input Capacitance	N. <u>-</u>	V _{IN} =0V, f=250kHz	—		5	pF
C _{OUT}	Output Capacitance	_	V _{OUT} =0V, f=250kHz	_		5	pF

D.C. Characteristics



勝特力材料 886-3-5753170 胜特力电子(上海) 86-21-54151736

胜特力电子(深圳) 86-755-83298787

Http://www. 100y. com. tw

HT93LC46

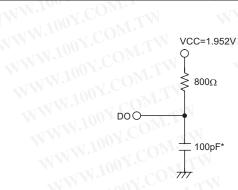
A.C. Characteristics

Symbol	Parameter		5V±10%		3V±10%		=2.2V	Unit
WT.	NI	Min.	Max.	Min.	Max.	Min.	Max.	
f _{SK}	Clock Frequency	0	2000	0	500	0	250	kHz
tsкн	SK High Time	250	ONT.	1000	WHY I	2000	COM.	ns
t _{SKL}	SK Low Time	250	$0\overline{N}$	1000	NV7	2000	N.COM	ns
tcss	CS Setup Time	50	c_{Θ_M}	200		200	N.€OI	ns
t _{CSH}	CS Hold Time	0	, coM	0		0		ns
t _{CDS}	CS Deselect Time	250	$\frac{1}{100}$	250		1000	100 <u>×</u> .	ns
tDIS	DI Setup Time	100		200		400	1001.	ns
t DIH	DI Hold Time	100	00 <u>7.</u> 0	200	_	400	N.1001.	ns
t _{PD1}	DO Delay to "1"	NN T	250	T.T	1000	N.N.	2000	ns
t _{PD0}	DO Delay to "0"	M M M	250		1000	411	2000	ns
t _{SV}	Status Valid Time	V P V	250	COL	250		- 10	ns
t _{HV}	DO Disable Time	100	Q. <u>10</u> 00	400	17 m	400	WM.	ns
t _{PR}	Write Cycle Time		5		5		5	ms

A.C. Test Conditions

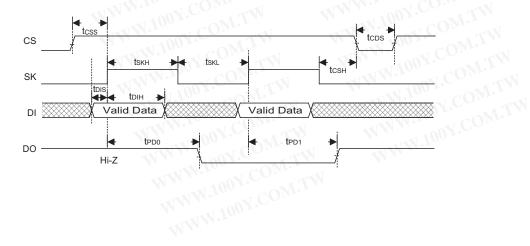
Input and output timing reference levels: 1.5V

Output load: See Figure right WWW.100Y.COM.T



*Including scope and jig

Output Load Circuit





Functional Description

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

HT93LC46

ERASE

The HT93LC46 is accessed via a three-wire serial communication interface. The device is arranged into 64 words by 16 bits or 128 words by 8 bits depending whether the ORG pin is connected to VCC or VSS. The HT93LC46 contains seven instructions: READ, ERASE, WRITE, EWEN, EWDS, ERAL and WRAL. When the user selectable internal organization is arranged into 64×16 (128×8), these instructions are all made up of 9(10) bits data: 1 start bit, 2 op code bits and 6(7) address bits.

By using the control signal CS, SK and data input signal DI, these instructions can be given to the HT93LC46. These serial instruction data presented at the DI input will be written into the device at the rising edge of SK. During the READ cycle, DO pin acts as the data output and during the WRITE or ERASE cycle, DO pin indicates the BUSY/READY status. When the DO pin is active for read data or as a BUSY/READY indicator the CS pin must be high; otherwise DO pin will be in a high-impedance state. For successful instructions, CS must be low once after the instruction is sent. After power on, the device is by default in the EWDS state. And, an EWEN instruction must be performed before any ERASE or WRITE instruction can be executed. The following are the functional descriptions and timing diagrams of all seven instructions.

READ

The READ instruction will stream out data at a specified address on the DO pin. The data on DO pin changes during the low-to-high edge of SK signal. The 8 bits or 16 bits data stream is preceded by a logical "0" dummy bit. Irrespective of the condition of the EWEN or EWDS instruction, the READ command is always valid and independent of these two instructions. After the data word has been read the internal address will be automatically incremented by 1 allowing the next consecutive data word to be read out without entering further address data. The address will wrap around with CS High until CS returns to LOW.

EWEN/EWDS

The EWEN/EWDS instruction will enable or disable the programming capabilities. At both the power on and power off state the device automatically entered the disable mode. Before a WRITE, ERASE, WRAL or ERAL instruction is given, the programming enable instruction EWEN must be issued, otherwise the ERASE/WRITE instruction is invalid. After the EWEN instruction is issued, the programming enable condition remains until power is turned off or a EWDS instruction is given. No data can be written into the device in the programming disabled state. By so doing, the internal memory data can be protected.

The ERASE instruction erases data at the specified addresses in the programming enable mode. After the ERASE op-code and the specified address have been issued, the data erase is activated by the falling edge of CS. Since the internal auto-timing generator provides all timing signals for the internal erase, so the SK clock is not required. During the internal erase, we can verify the busy/ready status if CS is high. The DO pin will remain low but when the operation is over, the DO pin will return to high and further instructions can be executed.

WRITE

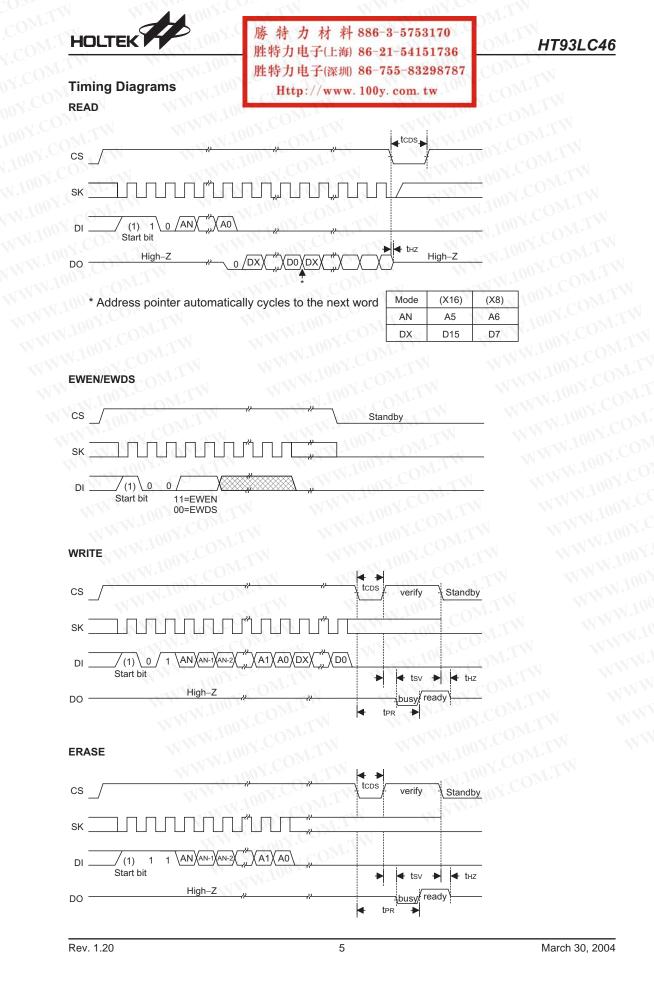
The WRITE instruction writes data into the device at the specified addresses in the programming enable mode. After the WRITE op-code and the specified address and data have been issued, the data writing is activated by the falling edge of CS. Since the internal auto-timing generator provides all timing signal for the internal writing, so the SK clock is not required. The auto-timing write cycle includes an automatic erase-before-write capability. So, it is not necessary to erase data before the WRITE instruction. During the internal writing, we can verify the busy/ready status if CS is high. The DO pin will remain low but when the operation is over, the DO pin will return to high and further instructions can be executed.

ERAL

The ERAL instruction erases the entire 64×16 or 128×8 memory cells to logical "1" state in the programming enable mode. After the erase-all instruction set has been issued, the data erase feature is activated by the falling edge of CS. Since the internal auto-timing generator provides all timing signal for the erase-all operation, so the SK clock is not required. During the internal erase-all operation, we can verify the busy/ready status if CS is high. The DO pin will remain low but when the operation is over, the DO pin will return to high and further instruction can be executed.

WRAL

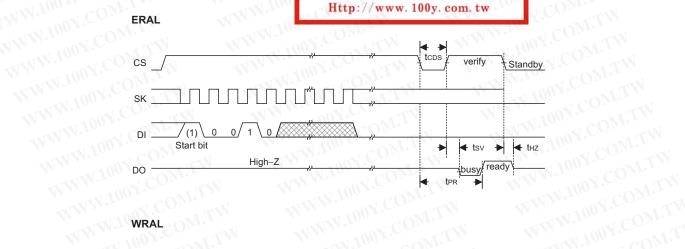
The WRAL instruction writes data into the entire 64×16 or 128×8 memory cells in the programming enable mode. After the write-all instruction set has been issued, the data writing is activated by the falling edge of CS. Since the internal auto-timing generator provides all timing signals for the write-all operation, so the SK clock is not required. During the internal write-all operation, we can verify the busy/ready status if CS is high. The DO pin will remain low but when the operation is over the DO pin will return to high and further instruction can be executed.

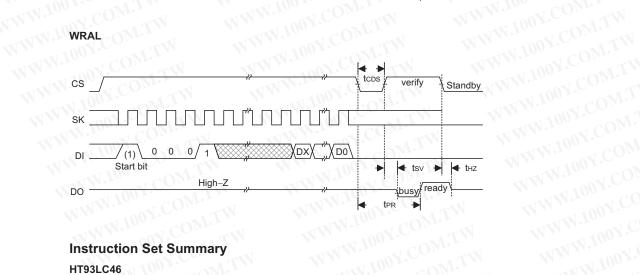




勝特力材料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

HT93LC46





Instruction Set Summary

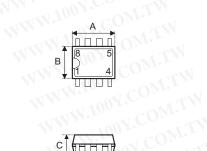
nstruction	Comments	Start bit	Op Code	Address ORG=0 ORG=1 X8 X16	Data ORG=0 ORG=1 X8 X16
READ	Read data	1	10	A6~A0 A5~A0	D7~D0 D15~D0
ERASE	Erase data	1	11	A6~A0 A5~A0	$W = W_{T}$
WRITE	Write data	1	01	A6~A0 A5~A0	D7~D0 D15~D0
EWEN	Erase/Write Enable	1	00	11XXXXX 11XXXX	1.T
EWDS 🚿	Erase/Write Disable	1	00	00XXXXX 00XXXX	M.T.Y -
RAL	Erase All	1	00	10XXXXX 10XXXX	-WILL
VRAL	Write All	1	00	01XXXXX 01XXXX	D7~D0 D15~D0

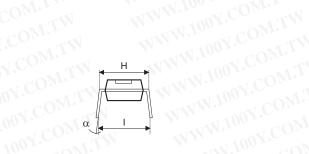


Package Information

WWW.100Y.CON

8-pin DIP (300mil) Outline Dimensions WWW.100Y.COM.TW





WWW.100Y.COM.TW

WWW.100

勝特力材料 886-3-5753170

胜特力电子(上海) 86-21-54151736

胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

Cumb al	Dimensions in mil					
Symbol	Min.	Nom.	Max.			
ACOM.	355	CONT.	375			
B ONL	240	100 1. CONT. 1	260			
C	125	100X. 01.TW	135			
D V.CO	125	100X 117W	145			
WW. E CON	16	WT. COMMENT	20			
N.F CO	50	N.In. COM.	70			
G	W.I.M	100				
WW H 100Y.C	295	100 <u>1.001</u> .T	315			
NWW.	335	Marine V.Co.	375			
α	0°	WWW. P. TV.COM.	15°			

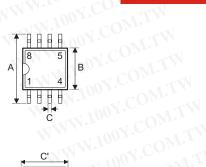
WWW.100Y.COM.T WWW.100V

7

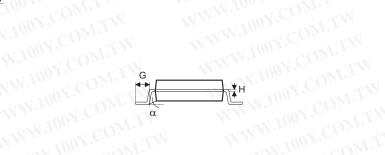
HT93LC46



8-pin SOP (150mil) Outline Dimensions WWW.100Y.COM.







WWW.100Y

WWW.100Y.COM.TW

勝特力材料 886-3-5753170

胜特力电子(上海) 86-21-54151736

胜特力电子(深圳) 86-755-83298787 Http://www. 100y. com. tw

N.COM.	Dimensions in mil				
Symbol	Min.	Nom.	Max.		
A OM	228	CON-	244		
B	149	ODI. CONTIN	157		
C	14	100Y. TW	20		
C' CO	189	NON COM TW	197		
WW. D COM.	53	COMP.	69		
W.10 COM	.T	50	TANN. IOU CO		
FOY	4	N.1001. COM.TW	10		
G	22	TIDOX.COMT	28		
WWH CC	4	WW. MONTON	12		
α	0 [°]	WW.10 TCOM.	10°		

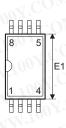
Rev. 1.20

WWW.100Y.COM.TW

HT93LC46



8-pin TSSOP Outline Dimensions WWW.100Y.COM.



特力材料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787

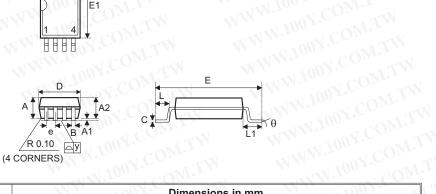
WWW.100Y.CC

WWW.100Y.COM.TW

WW.100Y.COM.TW

Http://www.100y.com.tw

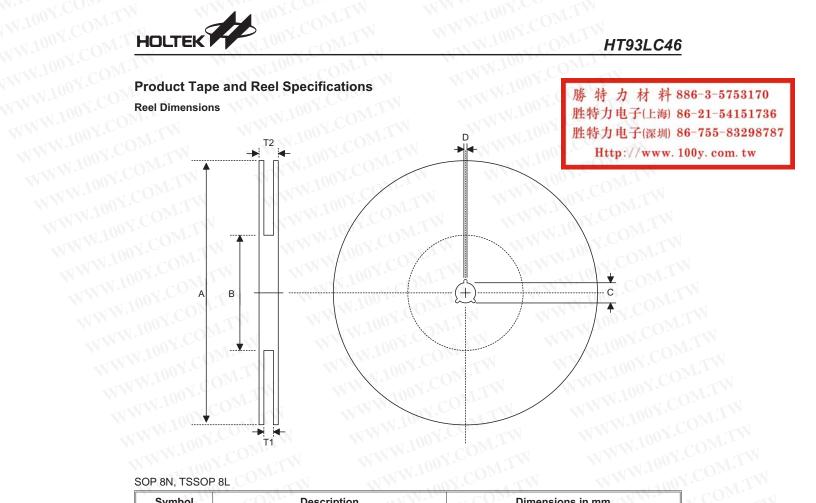
HT93LC46



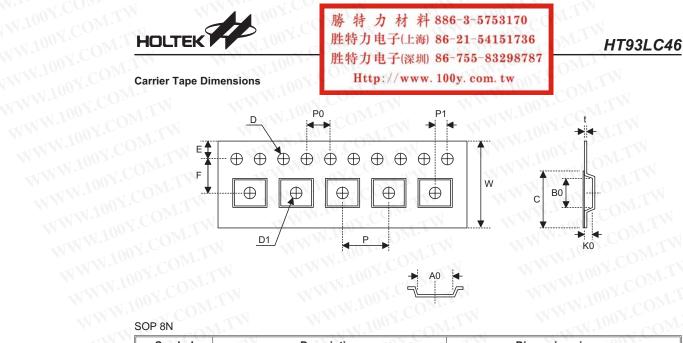
勝

100Y.COM TW	Dimensions in mm					
Symbol	Min.	Nom.	Max.	WITH		
AOM	1.05	N COM-	1.20	JAN		
A1	0.05	CONC.	0.15	DW		
A2	0.95	DOT. ONLITY	1.05	JOM.T		
B	M = MN	0.25	WW100Y	I.M.I		
C COM	0.11	N. COM	0.15	I.CO.		
D. CON	2.90	1.100 CON.	3.10	V.COM		
E	6.20	W^{1001}	6.60	CON		
E100Y.	4.30	100X - OM.TV	4.50			
e v C	$W = W_{T}$	0.65	N -NN	1001.00		
TWD.IVS C	0.50	WW.10 COMP.	0.70	J.V.C		
L1N.100	0.90	WW.100 COM.	1.10			
y 1001	L'MIT	100 r. ON	0.10	d.100 1.		
θ	0°	WWW HOY.CO	8°	1001		

WWW.100Y.CO WWW.100Y.COM.TW WWW



Symbol	Description	Dimensions in mm
A	Reel Outer Diameter	330±1.0
В	Reel Inner Diameter	62±1.5
С	Spindle Hole Diameter	13.0+0.5 -0.2
D	Key Slit Width	2.0±0.5
T1	Space Between Flange	12.8+0.3 _0.2
T2	Reel Thickness	18.2±0.2



JP 8N				
Symbol	Description	Dimensions in mm		
W.C	Carrier Tape Width	12.0+0.3 _0.1		
P	Cavity Pitch	8.0±0.1		
E	Perforation Position	1.75±0.1		
F	Cavity to Perforation (Width Direction)			
D100	Perforation Diameter	1.55±0.1		
D1	Cavity Hole Diameter	1.5+0.25		
P0	Perforation Pitch	4.0±0.1		
P1	Cavity to Perforation (Length Direction)	2.0±0.1		
A0	Cavity Length	6.4±0.1		
B0	Cavity Width	5.20±0.1		

TSSOP 8L

K0	Cavity Depth	2.1±0.1	
t	Carrier Tape Thickness	0.3±0.05	
С	Cover Tape Width	9.3	
OP 8L	WW.100Y.COM.TW WY	WW.100X.COM.TW WW	
Symbol √	Description	Dimensions in mm	
W	Carrier Tape Width	12.0+0.3 0.1	
Р	Cavity Pitch	avity Pitch 8.0±0.1	
Е	Perforation Position	1.75±0.1	
F	Cavity to Perforation (Width Direction)	on) 5.5±0.5	
D	Perforation Diameter 1.5+0.1		
D1	Cavity Hole Diameter 1.5+0.1		
P0	Perforation Pitch	4.0±0.1	
P1	Cavity to Perforation (Length Direction)	tion (Length Direction) 2.0±0.1	
A0	Cavity Length	7.0±0.1	
B0	Cavity Width	3.6±0.1	
K0	Cavity Depth	1.6±0.1	
t	Carrier Tape Thickness	0.3±0.013	
С	Cover Tape Width	9.3	

WY.COM.TW



勝特力材料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www. 100y. com. tw WW.100Y.COM.TW

WWW.1005



Holtek Semiconductor Inc. (Headquarters) No.3, Creation Rd. II, Science Park, Hsinchu, Taiwan Tel: 886-3-563-1999 Fax: 886-3-563-1189 http://www.holtek.com.tw

Holtek Semiconductor Inc. (Taipei Sales Office) 4F-2, No. 3-2, YuanQu St., Nankang Software Park, Taipei 115, Taiwan Tel: 886-2-2655-7070 Fax: 886-2-2655-7373 Fax: 886-2-2655-7383 (International sales hotline)

W.100Y.COM Holtek Semiconductor Inc. (Shanghai Sales Office) 7th Floor, Building 2, No.889, Yi Shan Rd., Shanghai, China 200233 Tel: 021-6485-5560 Fax: 021-6485-0313 http://www.holtek.com.cn

Holtek Semiconductor Inc. (Shenzhen Sales Office) 43F, SEG Plaza, Shen Nan Zhong Road, Shenzhen, China 518031 Tel: 0755-8346-5589 Fax: 0755-8346-5590 ISDN: 0755-8346-5591

Holtek Semiconductor Inc. (Beijing Sales Office) Suite 1721, Jinyu Tower, A129 West Xuan Wu Men Street, Xicheng District, Beijing, China 100031 Tel: 010-6641-0030, 6641-7751, 6641-7752 Fax: 010-6641-0125

Holmate Semiconductor, Inc. (North America Sales Office) 46712 Fremont Blvd., Fremont, CA 94538 Tel: 510-252-9880 Fax: 510-252-9885 http://www.holmate.com

Copyright © 2004 by HOLTEK SEMICONDUCTOR INC.

The information appearing in this Data Sheet is believed to be accurate at the time of publication. However, Holtek assumes no responsibility arising from the use of the specifications described. The applications mentioned herein are used solely for the purpose of illustration and Holtek makes no warranty or representation that such applications will be suitable without further modification, nor recommends the use of its products for application that may present a risk to human life due to malfunction or otherwise. Holtek's products are not authorized for use as critical components in life support devices or systems. Holtek reserves the right to alter its products without prior notification. For the most up-to-date information, please visit our web site at http://www.holtek.com.tw.